

NCEP01T18T

NCE N-Channel Super Trench Power MOSFET

Description

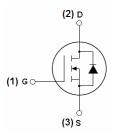
The NCEP01T18T uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{\text{DS(ON)}}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

General Features

- $V_{DS} = 100V, I_D = 180A$ $R_{DS(ON)} < 3.0 m\Omega @ V_{GS} = 10V$
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 175 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification



Schematic diagram



TO-247 top view

100% UIS TESTED!

100% AVds TESTED!

Package Marking and Ordering Information

| Device Marking | Device | Device Package | Reel Size | Tape width | Quantity |
|----------------|------------|----------------|-----------|------------|----------|
| NCEP01T18T | NCEP01T18T | TO-247 | - | - | - |

Absolute Maximum Ratings (T_c=25 ℃unless otherwise noted)

| Parameter | Symbol | Limit | Unit | |
|--|-----------------------|------------|------|--|
| Drain-Source Voltage | V _{DS} | 100 | V | |
| Gate-Source Voltage | V _{GS} | ±20 | V | |
| Drain Current-Continuous | I _D | 180 | А | |
| Drain Current-Continuous(T _C =100 °C) | I _D (100℃) | 128 | А | |
| Pulsed Drain Current | I _{DM} | 720 | Α | |
| Maximum Power Dissipation | P _D | 300 | W | |
| Derating factor | | 2 | W/°C | |
| Single pulse avalanche energy (Note 5) | E _{AS} | 1000 | mJ | |
| Operating Junction and Storage Temperature Range | T_{J}, T_{STG} | -55 To 175 | °C | |

Thermal Characteristic

| Thermal Resistance,Junction-to-Case ^(Note 2) | R _{θJC} | 0.5 | °C/W |
|---|------------------|-----|------|
|---|------------------|-----|------|



NCEP01T18T

Electrical Characteristics (T_C=25 ℃ unless otherwise noted)

| Parameter | Symbol | Condition | Min | Тур | Max | Unit |
|------------------------------------|---------------------|---|-----|-------|------|------|
| Off Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} =0V I _D =250μA | 100 | | - | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =100V,V _{GS} =0V | - | - | 1 | μA |
| Gate-Body Leakage Current | I _{GSS} | V _{GS} =±20V,V _{DS} =0V | - | - | ±100 | nA |
| On Characteristics (Note 3) | | | • | | | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS}=V_{GS}$, $I_{D}=250\mu A$ | 2.5 | - | 4.5 | V |
| Drain-Source On-State Resistance | R _{DS(ON)} | V _{GS} =10V, I _D =100A | - | | 3.0 | mΩ |
| Forward Transconductance | 9 FS | V _{DS} =10V,I _D =50A | 40 | - | - | S |
| Dynamic Characteristics (Note4) | | | • | | | |
| Input Capacitance | C _{lss} | V _{DS} =50V,V _{GS} =0V, | - | 11500 | - | PF |
| Output Capacitance | Coss | V _{DS} =50V,V _{GS} =0V, F=1.0MHz | - | 2480 | - | PF |
| Reverse Transfer Capacitance | C _{rss} | F=1.UIVITIZ | - | 75 | - | PF |
| Switching Characteristics (Note 4) | | | • | | | |
| Turn-on Delay Time | t _{d(on)} | | - | 25 | - | nS |
| Turn-on Rise Time | t _r | V_{DD} =50 V , I_D =100 A | - | 75 | - | nS |
| Turn-Off Delay Time | t _{d(off)} | V_{GS} =10 V , R_{G} =1.6 Ω | - | 89 | - | nS |
| Turn-Off Fall Time | t _f | | - | 29 | - | nS |
| Total Gate Charge | Q_g | V -50V/L -400A | - | 158 | | nC |
| Gate-Source Charge | Q _{gs} | V _{DS} =50V,I _D =100A, | - | 52 | | nC |
| Gate-Drain Charge | Q_{gd} | V _{GS} =10V | - | 29 | | nC |
| Drain-Source Diode Characteristics | | | • | | | |
| Diode Forward Voltage (Note 3) | V _{SD} | V _{GS} =0V,I _S =180A | - | | 1.2 | V |
| Diode Forward Current (Note 2) | Is | | - | - | 180 | Α |
| Reverse Recovery Time | t _{rr} | $T_J = 25^{\circ}C, I_F = I_S$ | - | 75 | | nS |
| Reverse Recovery Charge | Qrr | $di/dt = 100A/\mu s^{(Note3)}$ | - | 185 | | nC |

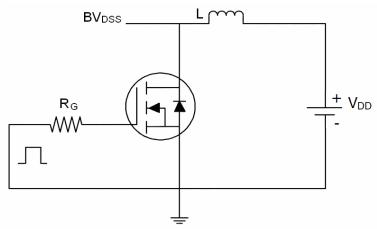
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^{\circ}\text{C}$,VDD=50V,VG=10V,L=0.5mH,Rg=25 Ω

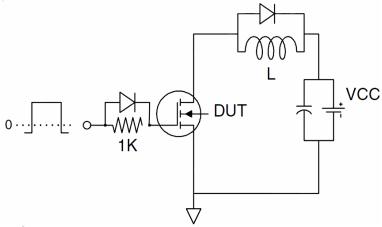


Test Circuit

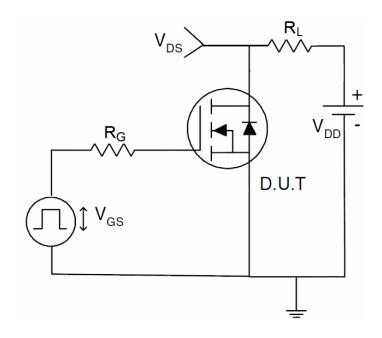
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit







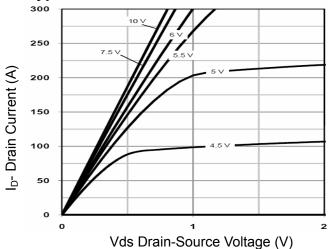


Figure 1 Output Characteristics

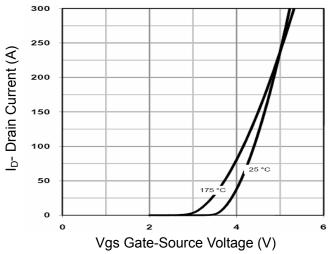


Figure 2 Transfer Characteristics

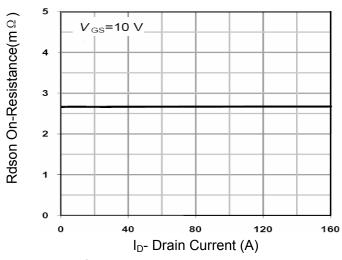


Figure 3 Rdson- Drain Current

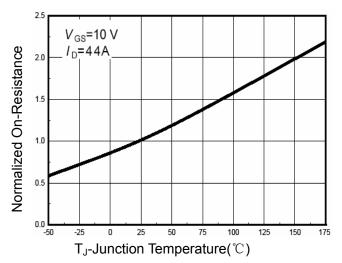


Figure 4 Rdson-Junction Temperature

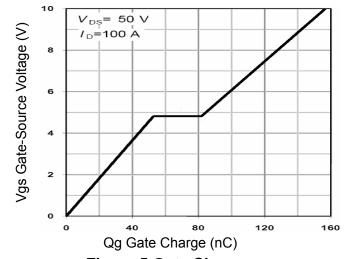


Figure 5 Gate Charge

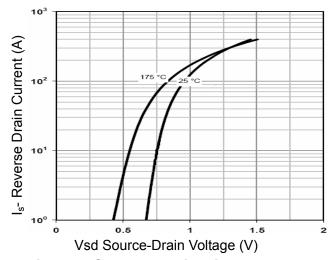


Figure 6 Source- Drain Diode Forward



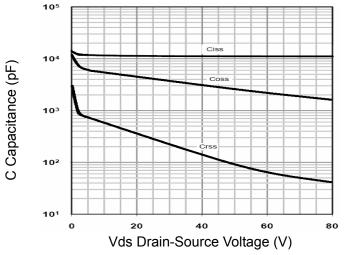


Figure 7 Capacitance vs Vds

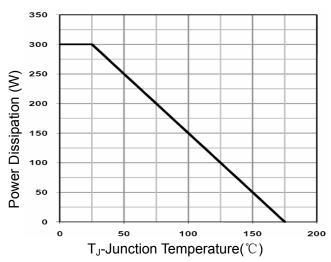


Figure 9 Power De-rating

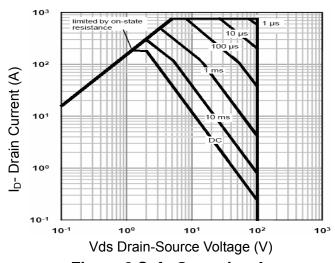


Figure 8 Safe Operation Area

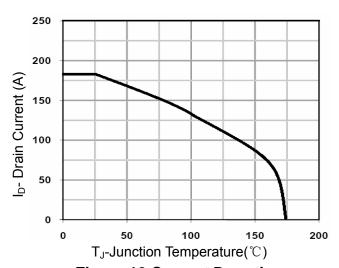
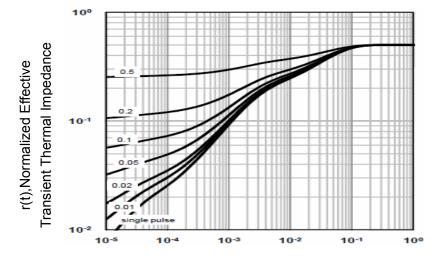


Figure 10 Current De-rating



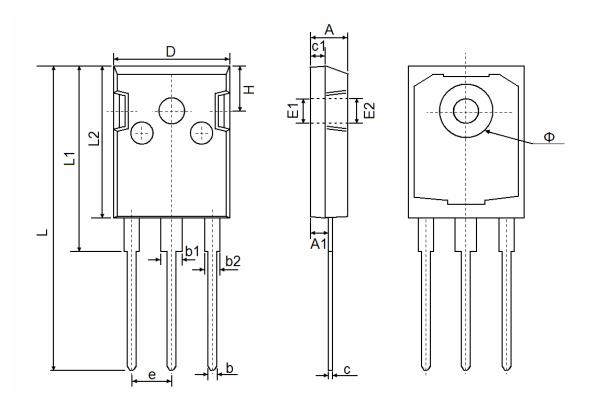
Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance

Pb Free Product



TO-247 Package Information



| Symbol | Dimensions | In Millimeters | Dimensions In Inches | | |
|--------|------------|-------------------|----------------------|-------|--|
| Symbol | Min. | Max. | Min. | Max. | |
| Α | 4.850 | 5.150 | 0.191 | 0.200 | |
| A1 | 2.200 | 2.600 | 0.087 | 0.102 | |
| b | 1.000 | 1.400 | 0.039 | 0.055 | |
| b1 | 2.800 | 3.200 | 0.110 | 0.126 | |
| b2 | 1.800 | 2.200 | 0.071 | 0.087 | |
| С | 0.500 | 0.700 | 0.020 | 0.028 | |
| c1 | 1.900 | 2.100 | 0.075 | 0.083 | |
| D | 15.450 | 15.750 | 0.608 | 0.620 | |
| E1 | 3.50 | 0 REF | 0.138 REF | | |
| E2 | 3.60 | 0 REF | 0.142 REF | | |
| L | 40.900 | 41.300 | 1.610 | 1.626 | |
| L1 | 24.800 | 25.100 | 0.976 | 0.988 | |
| L2 | 20.300 | 20.600 | 0.799 | 0.811 | |
| Ф | 7.100 | 7.300 | 0.280 | 0.287 | |
| е | 5.450 TYP | | 0.215 TYP | | |
| Н | 5.98 | 980 REF 0.235 REF | | | |



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NCEP01T18T

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